TOIREX

XP161A11A1PR-G

ETR1122_003

Power MOSFET

■GENERAL DESCRIPTION

The XP161A11A1PR-G is an N-channel Power MOSFET with low on-state resistance and ultra high-speed switching characteristics.

Because high-speed switching is possible, the IC can be efficiently set thereby saving energy.

A gate protect diode is built-in to prevent static damage.

The small SOT-89 package makes high density mounting possible.

■APPLICATIONS

- Notebook PCs
- Cellular and portable phones
- On-board power supplies
- Li-ion battery systems

■FEATURES

Low On-State Resistance : $Rds(on)=0.065 \Omega @ Vgs=10V$

: Rds(on)=0.105Ω@ Vgs=4.5V

Ultra High-Speed Switching Gate Protect Diode Built-in

Driving Voltage : 4.5V

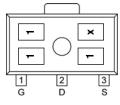
N-Channel Power MOSFET

DMOS Structure

Small Package : SOT-89

Environmentally Friendly: EU RoHS Compliant, Pb Free

■ PIN CONFIGURATION/ MARKING



G : Gate

S: Source

D: Drain

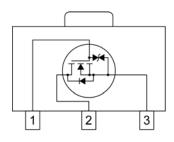
SOT-89 (TOP VIEW)

■ PRODUCT NAME

PRODUCTS	PACKAGE	ORDER UNIT
XP161A11A1PR	SOT-89	1,000/Reel
XP161A11A1PR-G ^(*)	SOT-89	1,000/Reel

^(*) The "-G" suffix denotes Halogen and Antimony free as well as being fully RoHS compliant.

■EQUIVALENT CIRCUIT



N-channel MOSFET (1 device built-in)

■ABSOLUTE MAXIMUM RATINGS

Ta = 25°C

	1a = 20						
PARAMETER	SYMBOL	RATINGS	UNITS				
Drain - Source Voltage	Vdss	30	V				
Gate - Source Voltage	Vgss	±20	V				
Drain Current (DC)	ld	4	Α				
Drain Current (Pulse)	ldp	16	Α				
Reverse Drain Current	ldr	4	Α				
Channel Power Dissipation *	Pd	2	W				
Channel Temperature	Tch	150	°C				
Storage Temperature	Tstg	-55~150	လူ				

^{*} When implemented on a ceramic PCB

^{*} x represents production lot number.

■ELECTRICAL CHARACTERISTICS

DC Characteristics $Ta = 25^{\circ}C$

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Drain Cut-Off Current	ldss	Vds=30V, Vgs= 0V	-	-	10	μΑ
Gate-Source Leak Current	lgss	Vgs= ±20V, Vds= 0V	-	-	±10	μΑ
Gate-Source Cut-Off Voltage	Vgs(off)	Id= 1mA, Vds= 10V	1.0	-	2.5	V
Drain-Source On-State Resistance*1	Rds(on)	Id= 2A, Vgs= 10V	-	0.05	0.065	Ω
		Id= 2A, Vgs= 4.5V	-	0.075	0.105	Ω
Forward Transfer Admittance *1	Yfs	ld= 2A, Vds= 10V	-	5.5	-	S
Body Drain Diode Forward Voltage	Vf	If= 4A, Vgs= 0V	-	0.85	1.1	V

^{*1} Effective during pulse test.

Dynamic Characteristics

 $Ta = 25^{\circ}C$

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Input Capacitance	Ciss	Vds= 10V, Vgs=0V f= 1MHz	-	270	-	pF
Output Capacitance	Coss		-	150	-	pF
Feedback Capacitance	Crss		-	55	-	pF

Switching Characteristics

 $Ta = 25^{\circ}C$

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Turn-On Delay Time	td (on)	Vgs= 5V, Id=2A Vdd= 10V	-	10	-	ns
Rise Time	tr		-	15	-	ns
Turn-Off Delay Time	td (off)		-	35	-	ns
Fall Time	tf		-	15	-	ns

Thermal Characteristics

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Thermal Resistance (Channel-Ambience)	Rth (ch-a)	Implement on a ceramic PCB	-	62.5	-	°C/W

Vds=10V, Pulse Test

. 125℃

=-55°C

3

4

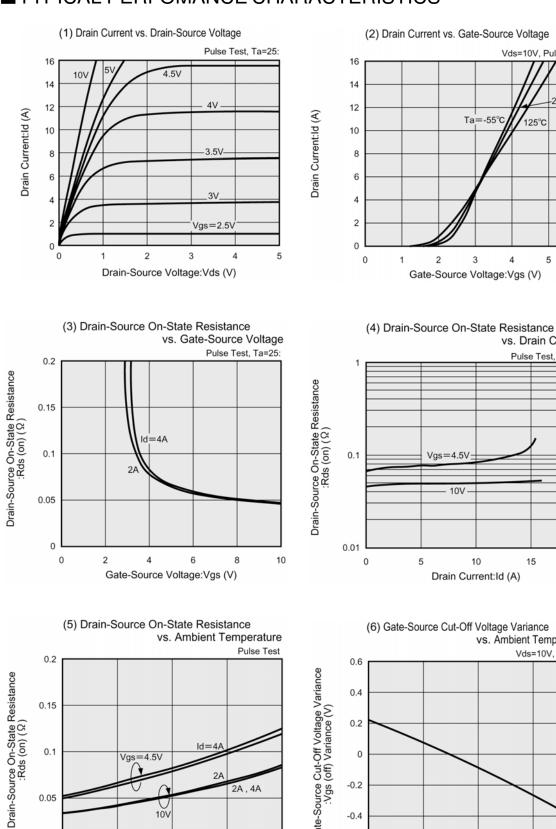
5

vs. Drain Current

Pulse Test, Ta=25:

6

■TYPICAL PERFOMANCE CHARACTERISTICS



2A , 4A

150

0.1

0.05

0

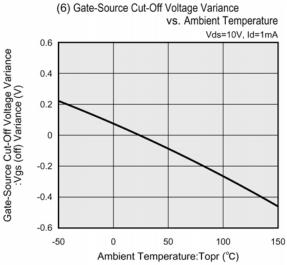
-50

Vgs=4.5V

0

10\

Ambient Temperature:Topr (°C)

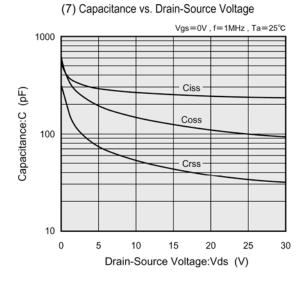


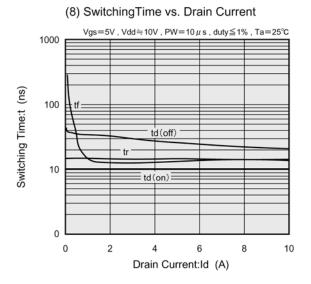
10

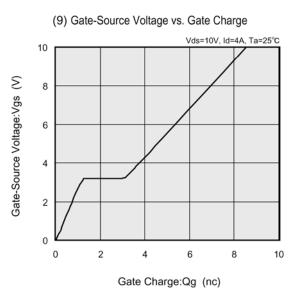
15

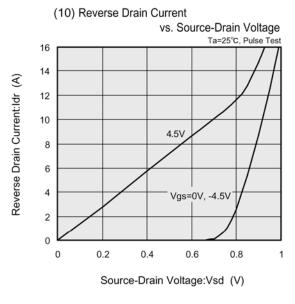
20

■TYPICAL PERFOMANCE CHARACTERISTICS (Continued)

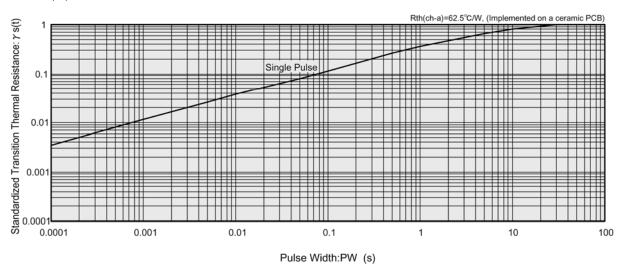








(11) Standardized transition Thermal Resistance vs. Pulse Width



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